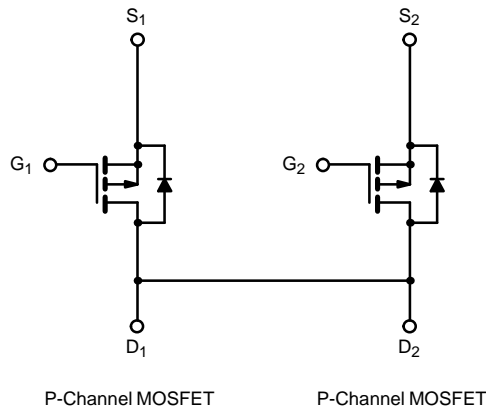
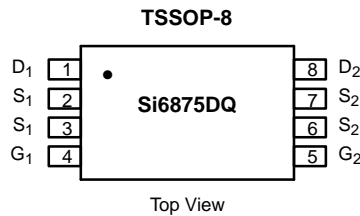




Dual P-Channel 20-V (D-S) MOSFET, Common Drain

TrenchFET[®]
Power MOSFETs
1.8-V Rated

PRODUCT SUMMARY		
V _{DS} (V)	r _{DS(on)} (Ω)	I _D (A)
-20	0.027 @ V _{GS} = -4.5 V	-6.4
	0.036 @ V _{GS} = -2.5 V	-5.5
	0.052 @ V _{GS} = -1.8 V	-4.6



ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C UNLESS OTHERWISE NOTED)					
Parameter		Symbol	10 secs	Steady State	Unit
Drain-Source Voltage		V _{DS}	-20		V
Gate-Source Voltage		V _{GS}	±8		
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 25 °C	I _D	-6.4	-5.2	A
	T _A = 70 °C		-5.1	-4.1	
Pulsed Drain Current (10 μs Pulse Width)		I _{DM}	-30		
Continuous Source Current (Diode Conduction) ^a		I _S	-1.6	-1.08	W
Maximum Power Dissipation ^a	T _A = 25 °C	P _D	1.78	1.19	
	T _A = 70 °C		1.14	0.76	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to 150		°C

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient ^a	t ≤ 10 sec	R _{thJA}	55	70	°C/W
	Steady State		85	105	
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	35	45	

Notes

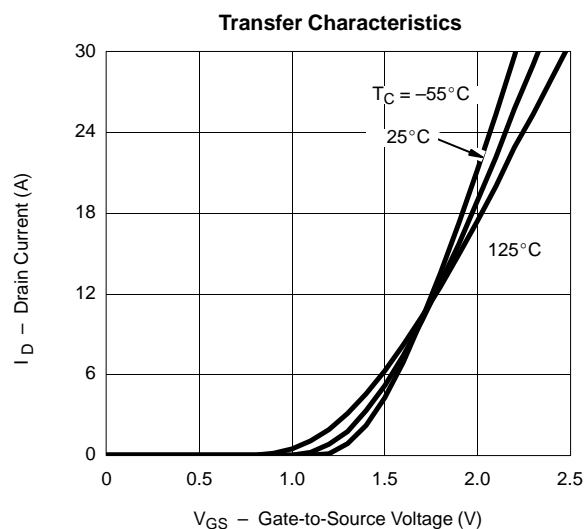
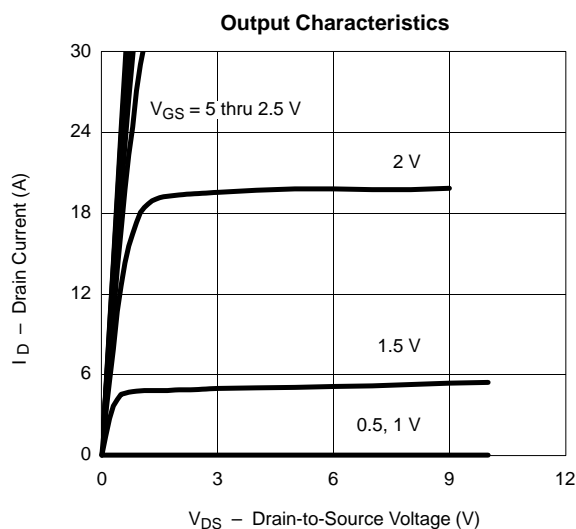
a. Surface Mounted on 1" x 1" FR4 Board.


SPECIFICATIONS ($T_J = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Static						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = -250 \mu\text{A}$	-0.45			V
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = -16 \text{ V}, V_{GS} = 0 \text{ V}$			-1	μA
		$V_{DS} = -16 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 70^\circ\text{C}$			-25	
On-State Drain Current ^a	$I_{D(on)}$	$V_{DS} = -5 \text{ V}, V_{GS} = -4.5 \text{ V}$	-20			A
Drain-Source On-State Resistance ^a	$r_{DS(on)}$	$V_{GS} = -4.5 \text{ V}, I_D = -6.4 \text{ A}$		0.022	0.027	Ω
		$V_{GS} = -2.5 \text{ V}, I_D = -5.5 \text{ A}$		0.029	0.036	
		$V_{GS} = -1.8 \text{ V}, I_D = -4.6 \text{ A}$		0.042	0.052	
Forward Transconductance ^a	g_{fs}	$V_{DS} = -5 \text{ V}, I_D = -6.4 \text{ A}$		19		S
Diode Forward Voltage ^a	V_{SD}	$I_S = -1.6 \text{ A}, V_{GS} = 0 \text{ V}$		-0.70	-1.1	V
Dynamic^b						
Total Gate Charge	Q_g	$V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V}, I_D = -6.4 \text{ A}$		26	36	nC
Gate-Source Charge	Q_{gs}		4.6			
Gate-Drain Charge	Q_{gd}		5.9			
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = -10 \text{ V}, R_L = 10 \Omega$ $I_D \cong -1 \text{ A}, V_{GEN} = -4.5 \text{ V}, R_G = 6 \Omega$		26	40	ns
Rise Time	t_r			27	40	
Turn-Off Delay Time	$t_{d(off)}$			170	250	
Fall Time	t_f			75	110	
Source-Drain Reverse Recovery Time	t_{rr}	$I_F = -1.6 \text{ A}, di/dt = 100 \text{ A}/\mu\text{s}$		30	50	

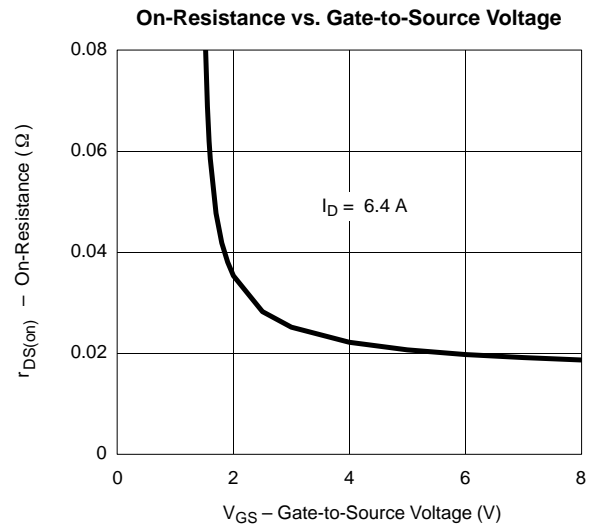
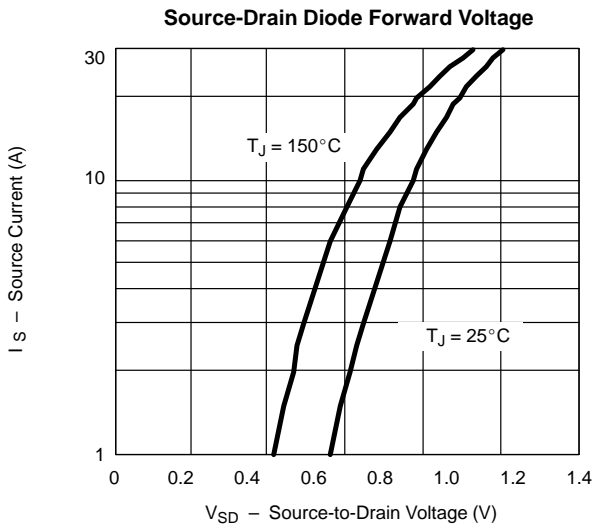
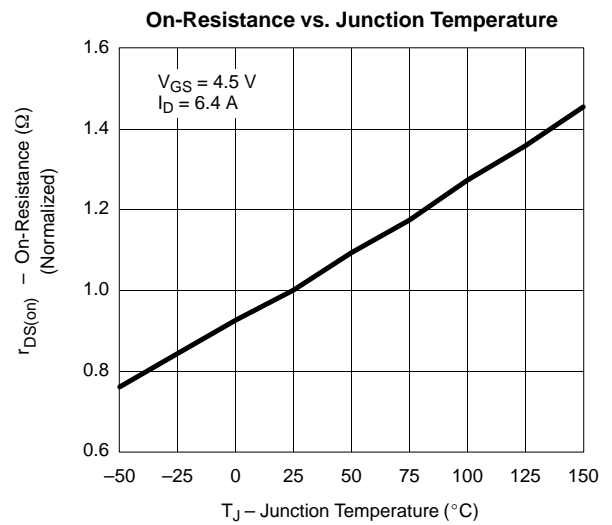
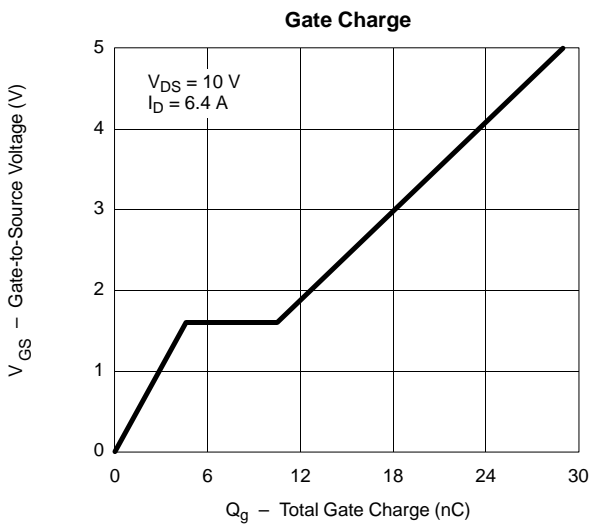
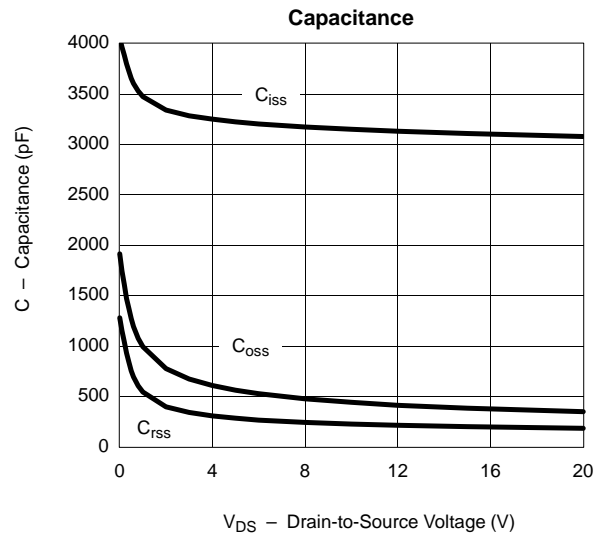
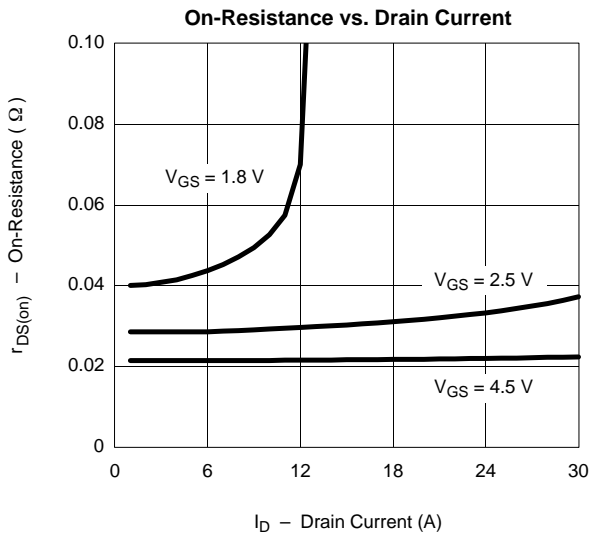
Notes

- a. Pulse test; pulse width $\leq 300 \mu\text{s}$, duty cycle $\leq 2\%$.
 b. Guaranteed by design, not subject to production testing.

TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)




TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)





TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)

